SLIS007A - D3299, AUGUST 1989 - REVISED MAY 1993

- 1-A Current Capability Per Channel
- 45-V Inductive Switching Voltage Capability
- Current Sink Inputs Compatible With TTL or CMOS Devices
- Output Clamp Diodes for Inductive Transient Protection
- Independent Thermal Shutdown Protection
- Overvoltage Shutdown Protection
- Independent Channel Current Limit
- Error Sensing
- Extended Temperature Range of -40°C to 125°C



The tab is electrically connected to the GND pins.

description

The TPIC2404 is a monolithic high-voltage high-current quadruple low-side switch especially

designed for driving from low-level logic to peripheral loads such as relays, solenoids, motors, lamps, and other high-voltage high-current loads. The high-efficiency power switch is optimized for applications where a very rugged power switch is required. The device tolerates power supply transients and reverse battery conditions up to 13 V.

The TPIC2404 features four inverting open-collector outputs controlled by a common-enable input. When ENABLE is low, the outputs are disabled. An error-sensing circuit monitors load and device faults. When an error is sensed, the FAULT output goes to a low state. In addition, the device features on-board  $V_{CC}$  overvoltage and thermal overload protection circuits, and the outputs are current limit protected.

	INPUT	S	OUTPUTS		
	ENABLE	Α	Y	FAULT	
	Н	Н	L	Н	
Normal operation	Н	L	Н	Н	
	L	Х	Н	Н	
Openleed	Н	L	L	L	
Openiload	Н	Н	L	Н	
Short to CND	Н	L	L	L	
Short to GND	Н	Н	L	Н	
	Н	Н	Н	L	
Overvollage shuldown	Н	L	Н	Н	
Thermal chutdown	Н	Н	Н	L	
mermai shuldown	Н	L	Н	Н	
Chart to V	Н	Н	Н	L	
SHOLL TO ACC	Н	L	Н	Н	

#### FUNCTION TABLE

H = high level, L = low level, X = irrelevant



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### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





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### schematics of inputs and outputs



## absolute maximum ratings over operating temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub> (see Note 1)	-13 V to 24	V
Output voltage range, $V_{0}$ (see Note 2)	$-0.6 \vee 107 \vee 0.6 \vee 0.6$	v v
Output sustaining voltage, $V_{O(sust)}$		V
Continuous output sink current (repetitive, t <sub>w</sub> < 8 ms), I <sub>OL</sub> (see Note 3)	1.5 A	4
Output clamp-diode voltage, V <sub>OK</sub>	45 \	V
Continuous total dissipation at (or below) 25°C case temperature (see Note 4)	50 W	V
Operating case or virtual junction temperature range5	5°C to 150°C	С
Storage temperature range	5°C to 150°C	С
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C	2

#### NOTES: 1. All voltage values are with respect to network GND.

2. For a fault condition to be valid, the output voltage needs to be a minimum of 7 V.

3. Output sink current is limited by the overcurrent limit.

FREE-AIR TEMPERATURE

4. For operation above 25°C free-air or case temperature, refer to Figures 1 and 2. To avoid exceeding the design maximum virtual junction temperature, these ratings should not be exceeded. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection can be activated at power levels slightly above or below rated dissipation.



#### CASE TEMPERATURE DISSIPATION DERATING CURVE





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## recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	9	12	16	V
High-level input voltage, VIH	2		5.5	V
Low-level input voltage, VIL	-0.3†		0.8	V
Peak output voltage from external inductive kickback			45	V
Continuous output sink current			1	А
FAULT output sink current			75	μΑ
Operating free-air temperature, T <sub>A</sub>	-40		125	°C

<sup>†</sup> The algebraic convention, in which the least positive (most negative) value is designated as minimum, is used in this data sheet for logic voltage levels.

# electrical characteristics over recommended ranges of operating free-air temperature and supply voltages (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	түр‡	MAX	UNIT		
			V <sub>O</sub> = 12 V,	ENABLE low		15	100	μA	
IO(off) Off-state output current			V <sub>O</sub> = 45 V,	ENABLE high		0.6	2	mA	
		V <sub>O</sub> = 12 V,	ENABLE high	200	400	600	μA		
۱ <sub>IL</sub>	Low-level input current		V <sub>I</sub> = 0 to 0.8 V		-10	25	40	μA	
		A inputs			10	25	60	μA	
ЧΗ	High-level input current	ENABLE				0.2	1	mA	
			I <sub>OL</sub> = 100 mA			0.1	0.15		
.,	Level and a device the set	_ow-level output voltage				0.3	0.55	v	
VOL Low-level output	Low-level output voltage					0.8	1.3		
			FAULT output,	I <sub>OL</sub> = 30 μA		0.2	0.4		
IOL	Low-level output current		FAULT output,	$V_{OL}$ = 1 V to 5.5 V	50	90	125	μA	
I <sub>R(K)</sub>	Clamp-diode reverse currer	ıt	V <sub>r</sub> = 50 V,	VO = 0			100	μA	
							2		
VF(K) Clamp-diode forward volta		e	I <sub>f</sub> = 1.5 A				2.5	V	
	Supply current		Outputs off,	ENABLE low			0.25	mA	
ICC			Outputs on,	$T_A = -40^{\circ}C$			120		
			Outputs on,	$T_A = 25^{\circ}C$ to $125^{\circ}C$			100	]	

# operating characteristics over recommended operating free-air temperature and supply voltages (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>‡</sup>	MAX	UNIT	
High-level output sense voltage threshold				7	V	
Low-level output sense voltage threshold		3			V	
Overvoltage shutdown		25.5		31	V	
Overvoltage shutdown hysteresis			0.25		V	
	$T_A = -40^{\circ}C$			1.85	A	
	$T_A = 25^{\circ}C$ to $125^{\circ}C$		1.2	1.5		
Thermal shutdown			155		°C	
Thermal shutdown hysteresis			15		°C	
Turn-on time			8		μs	
Turn-off time			8		μs	
<sup>‡</sup> All typical values are at V <sub>CC</sub> = 12 V, T <sub>A</sub> = 25°C.						

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